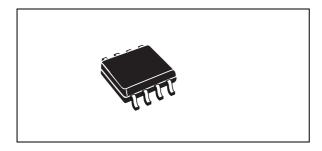


High voltage high and low-side driver

Datasheet - preliminary data



Features

- High voltage rail up to 600 V
- dV/dt immunity ±50 V/ns in full temperature range
- Driver current capability:
 - 290 mA source
 - 430 mA sink
- Switching times 75/35 ns rise/fall with 1 nF load
- 3.3 V, 5 V TTL/CMOS inputs with hysteresis
- Integrated bootstrap diode
- Compact and simplified layout
- Bill of material reduction
- · Effective fault protection
- · Flexible, easy and fast design

Applications

- Motor driver for home appliances
- Factory automation
- · Industrial drives and fans

Description

The L6395 is a high voltage device manufactured with BCD "OFF-LINE" technology. It is a single-chip high and low-side gate driver for N-channel power MOSFETs or IGBTs.

The high-side (floating) section is designed to stand a voltage rail up to 600 V. The logic inputs are CMOS/TTL compatible down to 3.3 V for easy interfacing microcontroller/DSP.

Table 1. Device summary

Order codes	Package	Packaging
L6395D	SO-8	Tube
L6395DTR	SO-8	Tape and reel

Contents L6395

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L6395 Block diagram

1 Block diagram

BOOTSTRAP DRIVER FLOATING STRUCTURE

BOOTSTRAP FLOATING

Figure 1. Block diagram

Pin connection L6395

2 Pin connection

Figure 2. Pin connection

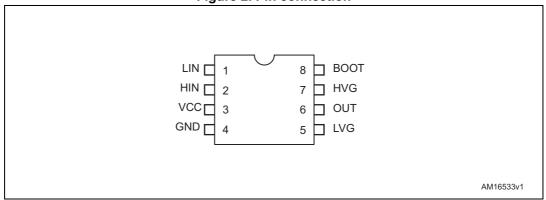


Table 2. Pin description

Pin	Pin name	Туре	Function
1	LIN	I	Low-side driver logic input (active high)
2	HIN	I High-side driver logic input (active h	
3	VCC	Р	Lower section supply voltage
4	GND	Р	Ground
5	LVG ⁽¹⁾	0	Low-side driver output
6	OUT	Р	High-side (floating) common voltage
7	HVG ⁽¹⁾	0	High-side driver output
8	BOOT	Р	Bootstrapped supply voltage

The circuit guarantees less than 1 V on the LVG and HVG pins (@I_{sink} = 10 mA), with V_{CC} > 3 V. In this
manner, the "bleeder", resistor connected between the gate and the source of the external MOSFET
normally used to hold the pin low, is omitted.

L6395 Truth table

3 Truth table

Table 3. Truth table

Inj	out	Out	put
LIN	HIN	LVG	HVG
L	L	L	L
L	Н	L	Н
Н	L	Н	L
Н	Н	Н	Н

Electrical data L6395

4 Electrical data

4.1 Absolute maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter	Va	Unit		
Symbol	raiailletei	Min.	Max.	Offic	
V _{CC}	Supply voltage	- 0.3	21	V	
V _{OUT}	Output voltage	V _{BOOT} - 21	V _{BOOT} + 0.3	V	
V _{BOOT}	Bootstrap voltage	- 0.3	620	V	
V _{hvg}	High-side gate output voltage	V _{OUT} - 0.3	V _{BOOT} + 0.3	V	
V _{lvg}	Low-side gate output voltage	- 0.3	V _{CC} + 0.3	V	
V _i	Logic input voltage	- 0.3	15	V	
dV _{OUT} /dt	Allowed output slew rate		50	V/ns	
P _{tot}	Total power dissipation (T _A = 25 °C)		800	mW	
TJ	Junction temperature		150	°C	
T _{stg}	Storage temperature	-50	150	°C	

4.2 Thermal data

Table 5. Thermal data

Symbol	Parameter	SO-8	Unit
R _{th(JA)}	Thermal resistance junction-to-ambient	150	°C/W

4.3 Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Pin	Parameter	Test condition	Va	Unit	
Syllibol	FIII	raiailletei	rest condition	Min.	Max.	Oill
V _{CC}	3	Supply voltage		10	20	V
V _{BO} ⁽¹⁾	8-6	Floating supply voltage		9.4	20	٧
V _{OUT}	6	Output voltage ⁽¹⁾		-11 ⁽²⁾	580	V
f_{SW}		Switching frequency	HVG, LVG load C _L = 1 nF		800	kHz
T_J		Junction temperature		-40	125	°C

^{1.} $V_{BO} = V_{BOOT} - V_{OUT}$

^{2.} LVG off. V_{CC} = 10 V. Logic is operational if V_{boot} > 5 V

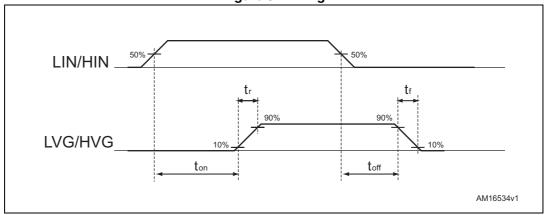
5 Electrical characteristics

5.1 AC operation

Table 7. AC operation electrical characteristics (V $_{cc}$ = 15 V; T $_{j}$ = +25 °C)

Symbol	Pin	Parameter	Test condition	Value			Unit
Syllibol	FIII	Farameter	rest condition	Min.	Тур.	Max.	Oill
t _{on}	1,2 vs 5,7	High/low-side driver turn-on propagation delay	$V_{OUT} = 0 V$ $V_{BOOT} = V_{cc}$ $C_L = 1 nF$ $V_{IN} = 0 to 3.3 V$ see Figure 3	50	125	200	ns
t _{off}	1,2 vs 5,7	High/low-side driver turn-off propagation delay	$V_{OUT} = 0 V$ $V_{BOOT} = V_{cc}$ $C_L = 1 nF$ $V_{IN} = 3.3 V to 0$ see Figure 3	50	125	200	ns
t _r	5, 7	Rise time	C _L = 1 nF		75	120	ns
t _f	5, 7	Fall time	C _L = 1 nF		35	70	ns

Figure 3. Timing



Electrical characteristics L6395

5.2 DC operation

 $(V_{cc} = 15 \text{ V}; T_j = +25 \text{ °C})$

Table 8. DC operation electrical characteristics

Symbol	Di-	Bows atom. Took cond.	Total condition		Value			
Symbol Pin		Parameter	Test condition	Min.	Тур.	Max.	Unit	
Low supply	Low supply voltage section							
V _{CC_hys}	3	V _{CC} UV hysteresis		0.6	0.7	0.8	V	
V _{CC_thON}	3	V _{CC} UV turn ON threshold		9	9.5	10	V	
V _{CC_thOFF}	3	V _{CC} UV turn OFF threshold		8.3	8.8	9.3	V	
I _{qccu}	3	Undervoltage quiescent supply current	$V_{CC} = 7 V$ LIN = 5V; HIN = GND;	40	90	150	μΑ	
I _{qcc}	3	Quiescent current	V _{CC} = 15 V LIN = 5 V; HIN = GND;	100	220	350	μА	
Bootstrapp	ed sup	ply voltage section ⁽¹⁾			•	•		
V _{BO_hys}	8	V _{BO} UV hysteresis		0.5	0.6	0.7	٧	
V _{BO_thON}	8	V _{BO} UV turn ON threshold		7.9	8.6	9.4	V	
V _{BO_thOFF}	8	V _{BO} UV turn OFF threshold		7.3	8	8.7	V	
I _{QBOU}	8	Undervoltage V _{BO} quiescent current	$V_{BO} = 7 \text{ V}$ LIN = GND; HIN = 5 V;	10	30	60	μΑ	
I _{QBO}	8	V _{BO} quiescent current	V _{BO} = 15 V LIN = GND; HIN = 5 V;		190	220	μΑ	
I _{LK}	8	High voltage leakage current	V _{hvg} = V _{OUT} = V _{BOOT} = 600V			10	μΑ	
R _{DS(on)}		Bootstrap driver on- resistance ⁽²⁾	LVG on		120		Ω	
Driving bu	ffer sec	tion						
I _{so}	5, 7	High/low-side source short- circuit current	$V_{IN} = V_{ih} (t_p < 10 \mu s)$	200	290		mA	
l _{si}	5, 7	High/low-side sink short- circuit current	$V_{IN} = V_{ii} (t_p < 10 \mu s)$	250	430		mA	
Logic inpu	Logic inputs							
V _{il}	1, 2	Low level logic threshold voltage		0.8		1.1	V	
V _{ih}	1, 2	High level logic threshold voltage		1.9		2.25	V	
I _{HINh}	2	HIN logic "1" input bias current	HIN = 15 V	10	40	100	μΑ	

Table 8. DC operation electrical characteristics (continued)

Cymhal	Pin	. Davamatar	Test condition	Value			Unit
Symbol	Symbol Pin Paramet		lest condition		Тур.	Max.	Unit
I _{HINI}	2	HIN logic "0" input bias current	HIN = 0 V			1	μΑ
I _{LINh}	1	LIN logic "1" input bias current LIN = 15 V		10	40	100	μΑ
I _{LINI}	1	LIN logic "0" input bias current	LIN = 0 V			1	μΑ

^{1.} $V_{BO} = V_{BOOT} - V_{OUT}$

^{2.} $R_{DS(on)}$ is tested in the following way: $R_{DS(on)} = [(V_{CC} - V_{CBOOT1}) - (V_{CC} - V_{CBOOT2})] / [I_1(V_{CC}, V_{CBOOT1}) - I_2(V_{CC}, V_{CBOOT2})]$ where I_1 is pin 8 current when $V_{CBOOT} = V_{CBOOT1}$, I_2 when $V_{CBOOT} = V_{CBOOT2}$.

6 Typical application diagram

Figure 4. Application diagram

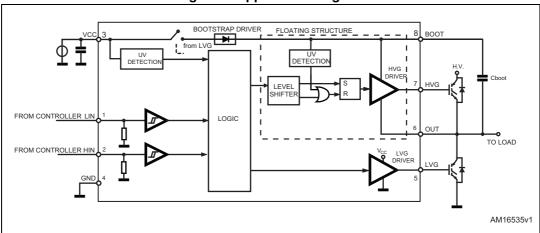
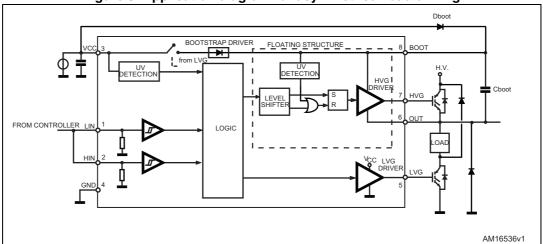


Figure 5. Application diagram for asymmetrical load driving



L6395 Bootstrap driver

7 Bootstrap driver

A bootstrap circuitry is needed to supply the high-voltage section. This function is normally accomplished using a high-voltage fast recovery diode (*Figure 6*). In the L6395 a patented integrated structure replaces the external diode. It is implemented using a high voltage DMOS, driven synchronously with the low-side driver (LVG), with diode in series, as shown in *Figure 7*. An internal charge pump provides the DMOS driving voltage.

7.1 C_{BOOT} selection and charging

To select the proper C_{BOOT} value the external MOS can be seen as an equivalent capacitor. This capacitor C_{EXT} is related to the MOS total gate charge:

Equation 1

$$C_{EXT} = \frac{Q_{gate}}{V_{gate}}$$

The ratio between the capacitors C_{EXT} and C_{BOOT} is proportional to the cyclical voltage loss.

It must be:

Equation 2

E.g.: if Q_{gate} is 30 nC and V_{gate} is 10 V, C_{EXT} is 3 nF. With C_{BOOT} = 100 nF the drop is 300 mV.

If HVG needs to be supplied for an extended period, the C_{BOOT} selection has to take into account also the leakage and quiescent losses.

E.g.: HVG steady-state consumption is lower than 220 μ A, so if HVG T_{ON} is 5 ms, C_{BOOT} must supply 1.1 μ C to C_{EXT}. This charge on a 1 μ F capacitor means a voltage drop of 1.1 V.

The internal bootstrap driver offers some important advantages: the external fast recovery diode can be avoided (it usually has a high leakage current).

This structure can work only if V_{OUT} is close to GND (or lower) and, at the same time, the LVG is on. The charging time (T_{charge}) of the C_{BOOT} is the time in which both conditions are fulfilled and it has to be long enough to charge the capacitor.

The bootstrap driver introduces a voltage drop due to the DMOS $R_{DS(on)}$ (typical value: 120 Ω). At low switching frequency, this drop can be neglected but, operating at high switching frequency, it should be taken into account.

The following equation is useful to compute the drop on the bootstrap DMOS:

Equation 3

$$V_{drop} = I_{charge} \cdot R_{DS(on)} \rightarrow V_{drop} = \frac{Q_{gate}}{T_{charge}} \cdot R_{DS(on)}$$

Bootstrap driver L6395

where Q_{gate} is the gate charge of the external power MOSFET, $R_{DS(on)}$ is the on-resistance of the bootstrap DMOS and T_{charge} is the charging time of the bootstrap capacitor.

For example: using a power MOSFET with a total gate charge of 30 nC, the drop on the bootstrap DMOS is about 1 V, if the T_{charge} is 5 μs .

Equation 4

$$V_{drop} = \frac{30_{nc}}{5_{us}} \cdot 120\Omega \cong 0.7V$$

 V_{drop} must be taken into account when the voltage drop on C_{BOOT} is calculated: whether this drop is too high, or the circuit topology does not allow a sufficient charging time, an external diode can be used.

Figure 6. Bootstrap driver with high voltage fast recovery diode

DBOOT

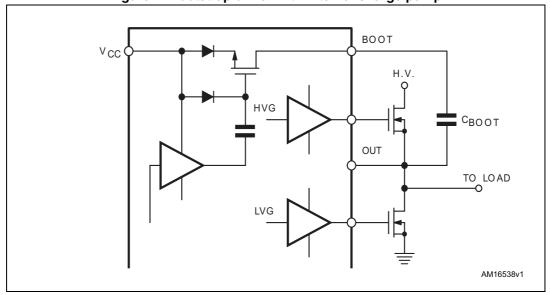
HVG

HVG

TO LOAD

AM16537v1

Figure 7. Bootstrap driver with internal charge pump



8 Package mechanical data

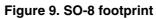
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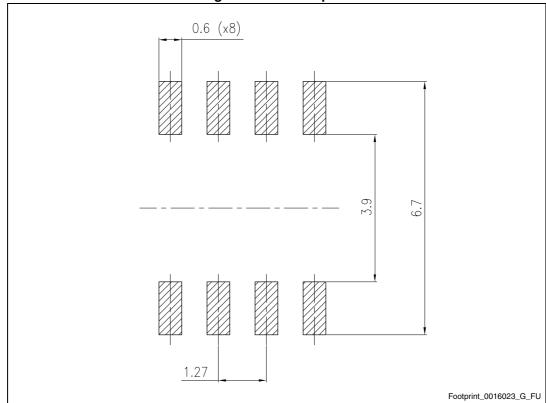
Table 9. SO-8 mechanical data

Dim	mm				
Dim.	Min.	Тур.	Max.		
А			1.75		
A1	0.10		0.25		
A2	1.25				
b	0.31		0.51		
b1	0.28		0.48		
С	0.10		0.25		
c1	0.10		0.23		
D	4.80	4.90	5.00		
E	5.80	6.00	6.20		
E1	3.80	3.90	4.00		
е		1.27			
h	0.25		0.50		
L	0.40		1.27		
L1		1.04			
L2		0.25			
k	0°		8°		
ccc			0.10		

41 □ ccc C SEATING PLANE 0,25 mm GAGE PLANE C SECTION B-B BASE METAL 0016023_G_FU

Figure 8. SO-8 package drawing





L6395 Revision history

9 Revision history

Table 10. Document revision history

Date	Revision	Changes
20-Mar-2013	1	Initial release.

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